

#### **Description**

The NTTFS4824NTAG uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

#### **General Features**

 $V_{DS} = 30V I_{D} = 100A$ 

 $R_{DS(ON)} < 5.5 \,\text{m}\Omega$  @  $V_{GS}=10V$ 

## **Application**

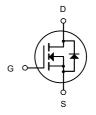
**Battery protection** 

Load switch

Uninterruptible power supply



DFN3X3-8L



N-Channel MOSFET

# **Package Marking and Ordering Information**

Product ID	Pack	Brand	Qty(PCS)
NTTFS4824NTAG	DFN3X3-8L	HXY MOSFET	5000

### Absolute Maximum Ratings (TC=25°C unless otherwise specified)

Symbol	Parameter	Rating	Units
V <sub>D</sub> s	Drain-Source Voltage 30		V
VGS	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	100	Α
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	70	Α
Ірм	Pulsed Drain Current <sup>2</sup>	192	Α
EAS	Single Pulse Avalanche Energy <sup>3</sup>	144.7	mJ
las	Avalanche Current	53.8	Α
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation <sup>4</sup>	62.5	W
P <sub>D</sub> @T <sub>A</sub> =25°C	Total Power Dissipation <sup>4</sup>	4.5	W
Тэтс	Storage Temperature Range	-55 to 150	Ŋ
TJ	Operating Junction Temperature Range	-55 to 150	°C
R <sub>θ</sub> JA	Thermal Resistance Junction-ambient <sup>1</sup>	62	°C/W
R <sub>e</sub> Jc	Thermal Resistance Junction-Case <sup>1</sup>	2.4	°C/W



### Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BVDSS	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			V
△BV <sub>DSS</sub> /△TJ	BVDSS Temperature Coefficient	Reference to 25°C , I <sub>D</sub> =1mA		0.0213		V/°C
		V <sub>GS</sub> =10V , I <sub>D</sub> =30A		4	5.5	
Rds(on)	Static Drain-Source On- Resistance <sup>2</sup>	V <sub>GS</sub> =4.5V , I <sub>D</sub> =15A		5.2	6	mΩ
V <sub>G</sub> S(th)	Gate Threshold Voltage		1.0		2.5	V
$\triangle V$ GS(th)	V <sub>GS(th)</sub> Temperature Coefficient	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA		-5.8		mV/°C
Inec	IDSS Drain-Source Leakage Current $\frac{T_J=25}{V_{DS}=2}$	V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1	uA
IDSS		V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C			5	
lgss	Gate-Source Leakage Current	$V_{GS}$ = $\pm 20V$ , $V_{DS}$ = $0V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =30A		26.5		S
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		1.4		Ω
Qg	Total Gate Charge (4.5V)			31.6		
Qgs	Gate-Source Charge	V <sub>DS</sub> =15V , V <sub>GS</sub> =4.5V , I <sub>D</sub> =15A		8.6		nC
Qgd	Gate-Drain Charge	10-13A		11.7		
T <sub>d(on)</sub>	Turn-On Delay Time			9		
Tr	Rise Time	V <sub>DD</sub> =15V , V <sub>GS</sub> =10V ,		19		
T <sub>d(off)</sub>	Turn-Off Delay Time	R <sub>G</sub> =3.3Ω		58		ns
T <sub>f</sub>	Fall Time	_I <sub>D</sub> =15A		15.2		
Ciss	Input Capacitance			3075		
Coss	Output Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		400		pF
Crss	Reverse Transfer Capacitance	_		315		.
Is	Continuous Source Current <sup>1,6</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force			100	Α
Ism	Pulsed Source Current <sup>2,6</sup>	Current			192	Α
Vsp	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25°C			1	V

### Diode Characteristics

#### Note

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\leqq 300 us$  , duty cycle  $\leqq 2\%$
- 3 .The EAS data shows Max. rating . The test condition is  $V_{\text{DD}}\text{=}25\text{V}, V_{\text{GS}}\text{=}10\text{V}, L\text{=}0.1\text{mH}, I_{\text{AS}}\text{=}34\text{A}$
- 4. The power dissipation is limited by 150 °C junction temperature
- 5 .The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.

# **Typical Characteristics**

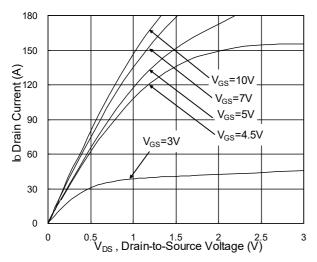


Fig.1 Typical Output Characteristics

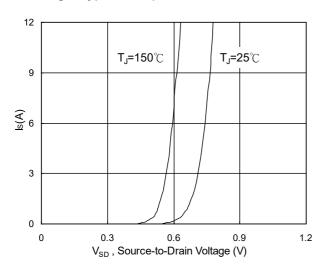


Fig.3 Forward Characteristics of Reverse

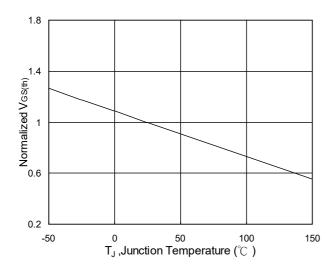


Fig.5 Normalized  $V_{\text{GS(th)}}$  vs.  $T_{\text{J}}$ 

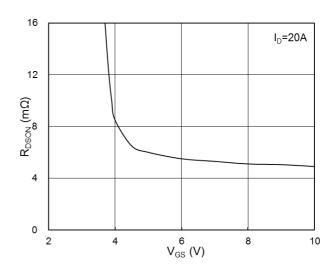


Fig.2 On-Resistance vs. G-S Voltage

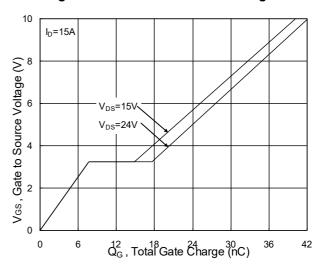


Fig.4 Gate-Charge Characteristics

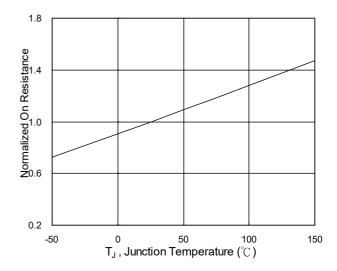
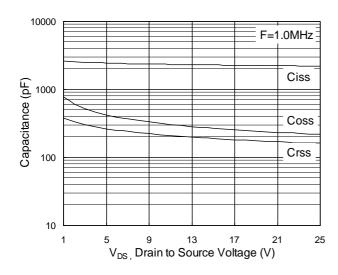


Fig.6 Normalized R<sub>DSON</sub> vs. T<sub>J</sub>



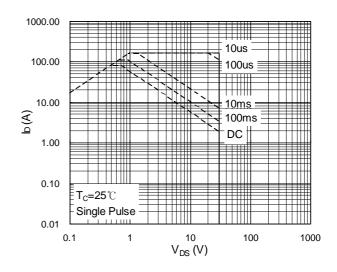


Fig.7 Capacitance

Fig.8 Safe Operating Area

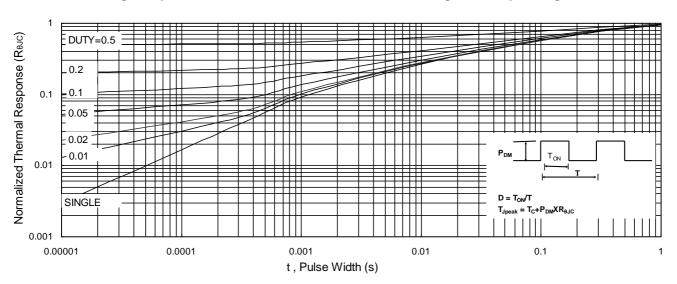


Fig.9 Normalized Maximum Transient Thermal Impedance

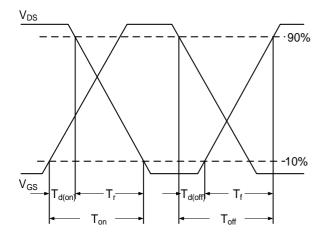


Fig.10 Switching Time Waveform

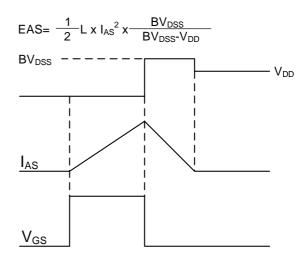
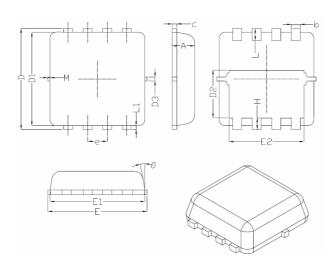


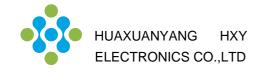
Fig.11 Unclamped Inductive Switching Waveform



# **DFN3X3-8L Package Information**



Sumb at	Dimensions In Millimeters		
Symbol	Min.	Nom.	Max.
A	0.70	0.75	0.80
b	0.25	0.30	0.35
С	0.10	0.15	0.25
D	3.25	3.35	3.45
D1	3.00	3.10	3.20
D2	1.48	1.58	1.68
D3	-	0.13	-
E	3.20	3.30	3.40
E1	3.00	3.15	3.20
E2	2.39	2.49	2.59
е	0.65BSC		
Н	0.30	0.39	0.50
L	0.30	0.40	0.50
L1	-	0.13	-
M	*	*	0.15
θ		10°	12 <sup>°</sup>



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